

# Surface Mount High Pass Filter

## EHPF-950-1+

50Ω 950 to 3000 MHz

### Features

- Miniature shielded package
- Low insertion loss
- High rejection

CASE STYLE: HE1354

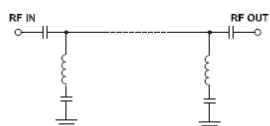
### Applications

- Defense/Military
- Military Radio Communication

### Electrical Specifications

Parameter		F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Stop Band	Rejection Loss	DC-F1	DC - 700	30	40	-	dB
	Insertion Loss	F2-F3	950 - 1200	-	0.9	2	dB
Pass Band	Insertion Loss	F3-F4	1200 - 2000	-	0.5	1	dB
	Insertion Loss	F4-F5	2000 - 3000	-	0.5	1	dB
Return Loss	Return Loss	F2-F4	950 - 2000	12	-	-	dB
	Return Loss	F4-F5	2000 - 3000	-	12	-	dB

### Functional Schematic



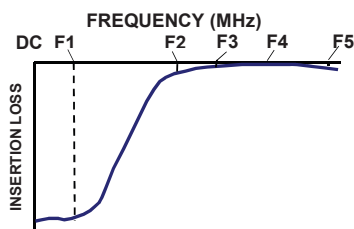
### Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	1 W

Permanent damage may occur if any of these limits are exceeded.

### Typical Performance Data at 25°C

### Typical Frequency Response



### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

### Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.  
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.  
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REV. OR  
ECO-002812  
EHPF-950-1+  
EDU3848  
URJ  
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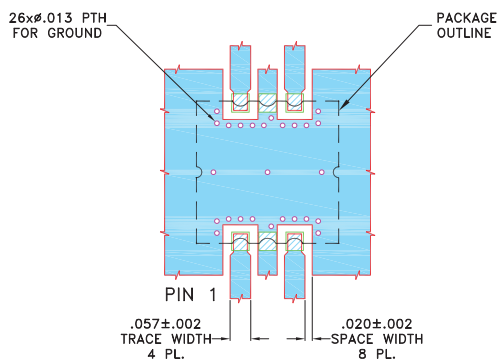


## Pad Connections

INPUT	1
OUTPUT	6
GROUND	2,5
NOT USED	3,4


**Demo Board MCL P/N: TB-XXXX+**  
**Suggested PCB Layout (PL-680)**

### SUGGESTED MOUNTING CONFIGURATION FOR HE1354 CASE STYLE



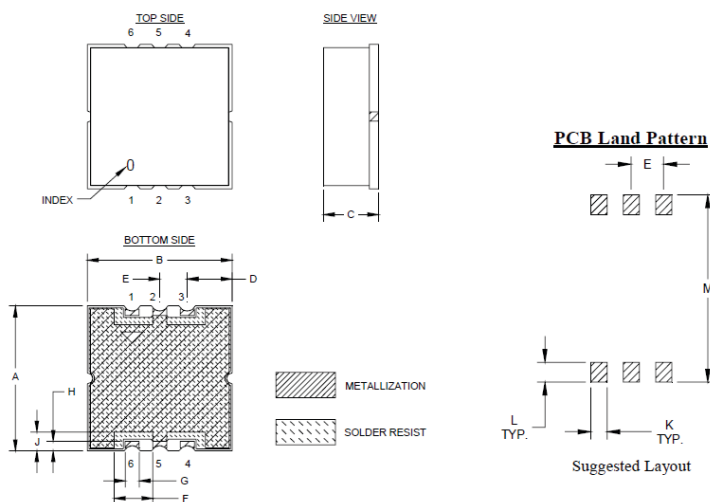
NOTES:

1. TRACE WIDTH IS SHOWN FOR ROGERS (R04350B) WITH DIELECTRIC THICKNESS .030"±.002". COPPER: 1/2 OZ. EACH SIDE.  
FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC  
(SOLDER MASK OVER BARE COPPER)

 DENOTES COPPER LAND PATTERN FREE OF SOLDERMASK

## Outline Drawing



### Outline Dimensions ( $\frac{\text{inch}}{\text{mm}}$ )

A	B	C	D	E	F	G	H	J	K
.394	.394	.150	.122	.075	.098	.038	.026	.051	.038
10.01	10.01	3.81	3.10	1.90	2.49	0.97	0.66	1.29	0.97
L	M								Wt.
.046	.434								grams
1.17	11.02								0.7

*Note: Please refer to case style drawing for details.*

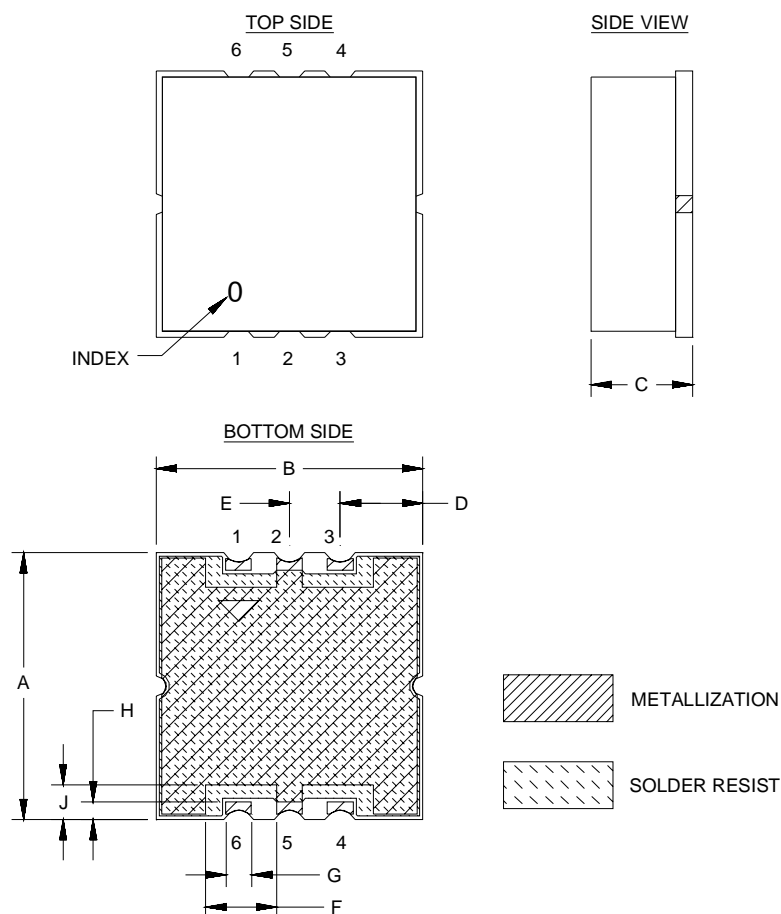
## Notes

**Notes:**

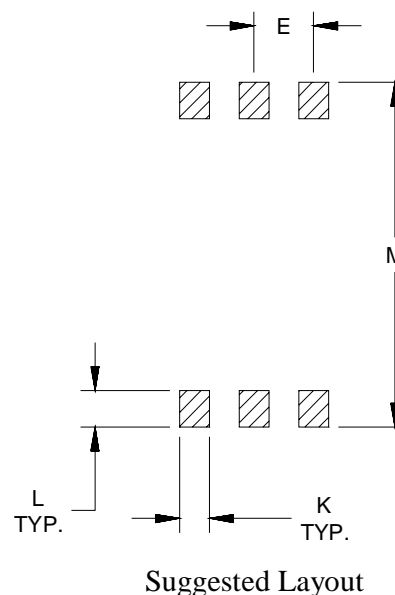
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### Outline Dimensions



### PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HE1354	.394 (10.01)	.394 (10.01)	.150 (3.81)	.122 (3.10)	.075 (1.90)	.098 (2.49)	.038 (0.97)	.026 (0.66)	.051 (1.29)	.038 (0.97)	.046 (1.17)	.434 (11.02)	0.7

Dimensions are in inches (mm). Tolerances: 2 Pl.  $\pm .03$ ; 3 Pl.  $\pm .015$

#### Notes:

- Case material: Nickel-Silver alloy.
- Base: Printed wiring laminate.
- Termination finish:
  - For RoHS Case Styles: 3-5  $\mu$  inch (.08-.13 microns) Gold over 120-240  $\mu$  inch (3.05-6.10 microns) Nickel plate.
  - For RoHS-5 Case Styles: Tin-Lead plate.



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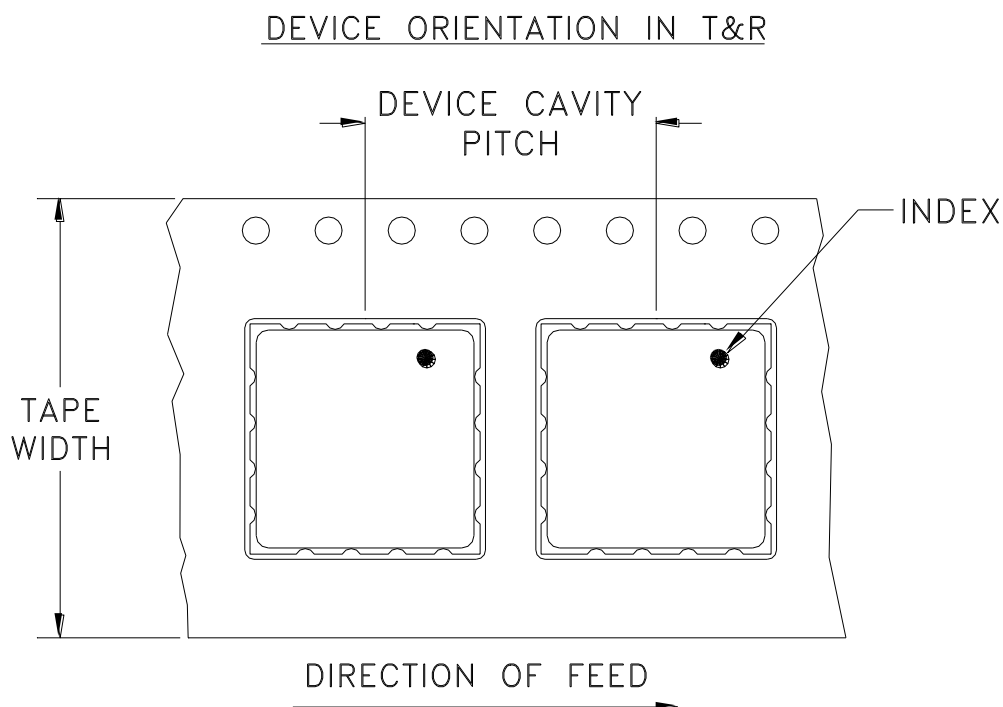
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RF/IF MICROWAVE COMPONENTS





# Tape & Reel Packaging TR-F37



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
24	16	7	Small quantity standards (see note)	10
				20
				50
				100
		13	Standard	200
				500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: [www.minicircuits.com/pages/pdfs/tape.pdf](http://www.minicircuits.com/pages/pdfs/tape.pdf)



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Mini-Circuits ISO 9001 & ISO 14001 Certified





All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutectic Process: 225°C peak Pb-Free Process, 245°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 20-2000 Hz, 4 times in each of three axes (total 12)	MIL-STD-883, Method 2007.3, Condition A
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215